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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent application of

: **Confirmation No. 8585**

Akihiro YAMAMOTO et al.

: Docket No. 2003_0945A

Serial No. 10/614,784

: Group Art Unit 1734

Filed July 9, 2003

: Examiner G. Koch

METHOD AND APPARATUS FOR
DETERMINING PROCESSING SIZE
OF BONDING MATERIAL

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEES FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975

Sir:

In response to the Office Action of May 5, 2004, please amend the above-identified U.S.
Patent application as follows: